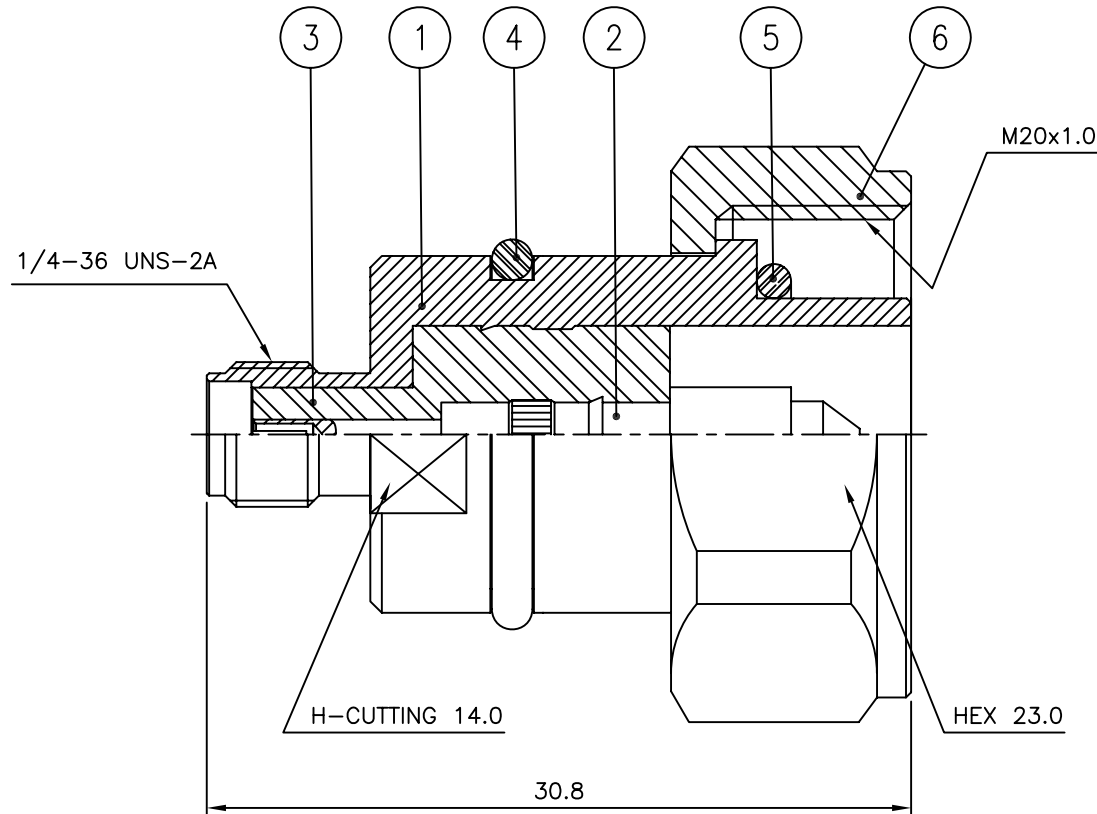


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2016.03.14.
1	[설번No.201904-0001] PIN 이탈 개선으로 인한 핀 변경	S.Y.EUN	I.C.KIM	2019.04.04.



6	CAP	1	MBsBD C3604BD-F	Nickel Plate	DCU02253-5/1
5	GASKET	1	SILICONE RUB		DGK00036-N/1
4	GASKET	1	SILICONE RUB		DGK00121-N/1
3	INSULATOR	1	TEFLON		DAI02466-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (5μm)	DAC03252-5/2 DAC03252-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate (5μm)	DAD00309-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2019. 04. 04.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE 4.1/9.5 DIN50 (P) SMA50 (J) ADAPTOR
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	3/1	DWG NO. AD00576-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	

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